APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

Title of Invention

A METHOD FOR FORMING A THIN COMPLETE HIGH-PERMITTIVITY

DIELECTRIC LAYER

Application Type: regular, utility

TTCA002 Attorney Docket Number:

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Customer Number: 26875

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Publication Information:

Suggested Figure for Publication - 3

Suggested Classification -

Suggested Technology Center -Total Number of Drawing Sheets - 9

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